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N-Channel 40V Fast Switching MOSFET

General Description

The QN4103M6N is the highest performance trench N-Channel MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The QN4103M6N meet the RoHS and Green Product requirement with full function reliability approved.

Product Sum	mary	Green RoHS \ HF \ (Pb)
BVDSS	RDSON (VGS=10V)	ID (TC=25°C)
40V	1.4mΩ	255A

Applications

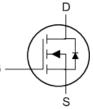
- Synchronous rectifier for Consumer/Computing
 /Industry Power Supply
- Motor
- Load Switch

Features

- Advanced high cell density Trench technology
- Green Device Available

PRPAK 5X6 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	40	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuou <mark>s Drain Current</mark> , V _{GS} @ 10V ¹	255	A
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	161	A
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	31	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	24	A
I _{DM}	Pulsed Drain Current ²	510	A
EAS	Single Pulse Avalanche Energy ³	1024.0	mJ
I _{AS}	Avalanche Current	64.0	A
P _D @T _C =25°C	Total Power Dissipation ⁴	156	W
P _D @T _A =25°C	Total Power Dissipation ⁴	2.3	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ. Max.		Unit	
R _{0JA}	Thermal Resistance Junction-Ambient ¹	43	54	°C/W	
R _{θJC}	Thermal Resistance Junction-Case	0.6	0.8	°C/W	

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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25° C , I _D =1mA		0.025		V/°C
Parata	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =50A		1.1	1.4	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =30A		1.5	2.0	11122
V _{GS(th)}	Gate Threshold Voltage	-V _{GS} =V _{DS} , I _D =250uA	1.2		2.5	v
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS, ID-2500A		-5.2		mV/°C
	Drain Source Lookage Current	V _{DS} =32V , V _{GS} =0V , T _J =25°C			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =32V , V _{GS} =0V , T _J =55°C			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		94.2		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		0.9		Ω
Qg	Total Gate Charge (10V)	V _{DS} =20V , V _{GS} =10V , I _D =3 <mark>0</mark> A		73.7		
Qg	Total Gate Charge (4.5V)			32.9		
Q _{gs}	Gate-Source Charge	V _{DS} =20V , V _{GS} =4.5 <mark>V</mark> , I _D =30A		16.3		nC
Q _{gd}	Gate-Drain Charge			7.2		1
T _{d(on)}	Turn-On Delay Time			15.2		
Tr	Rise Time	$V_{DD}=20V$, $V_{GS}=10V$, $R_{G}=3.3\Omega$		45.2		
T _{d(off)}	Turn-Off Delay Time	I _D =30A		53.0		ns
T _f	Fall Time			7.2		
Ciss	Input Capacitance			5450		
Coss	Output Capacitance	V _{DS} =20V , V _{GS} =0V , f=1MHz		996		pF
C _{rss}	Reverse Transfer Capacitance			35		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =50V , L=0.5mH , I _{AS} = 46A	529			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current ^{1,6}	$V_G = V_D = 0V$, Force Current			255	А
I _{SM}	Pulsed Source Current ^{2,6}				510	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V
trr	Reverse Recovery Time	IF=30A , di/dt=100A/µs , Tյ=25℃		44		nS
Qrr	Reverse Recovery Charge			50		nC

Note :

1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}50V, V_{\text{GS}}\text{=}10V, L\text{=}0.5mH$

4.The power dissipation is limited by 150 $^\circ\text{C}$ junction temperature

5.The Min. value is 100% EAS tested guarantee.

6.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.

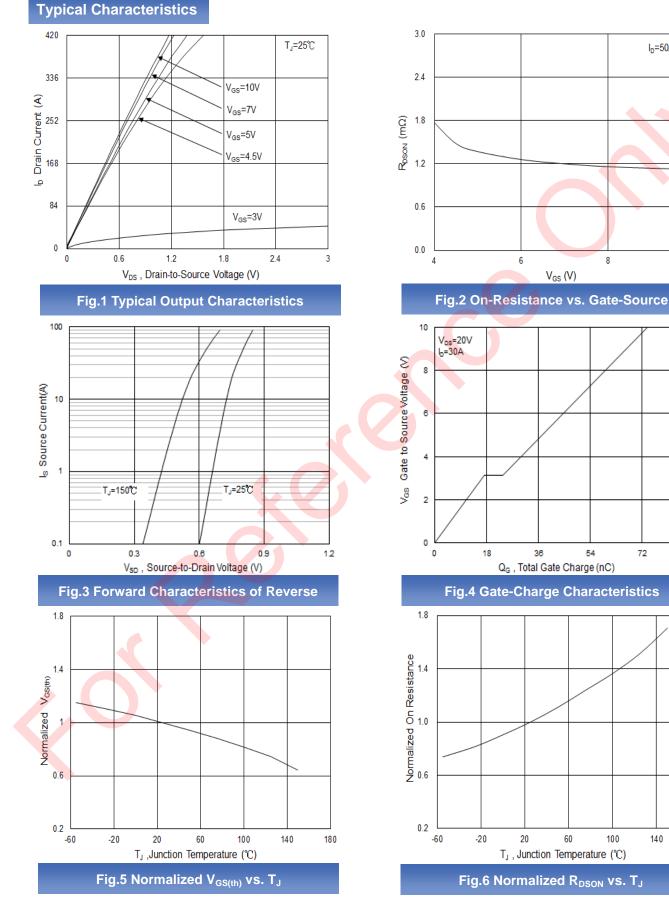
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I_D=50A

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140

180

72

90



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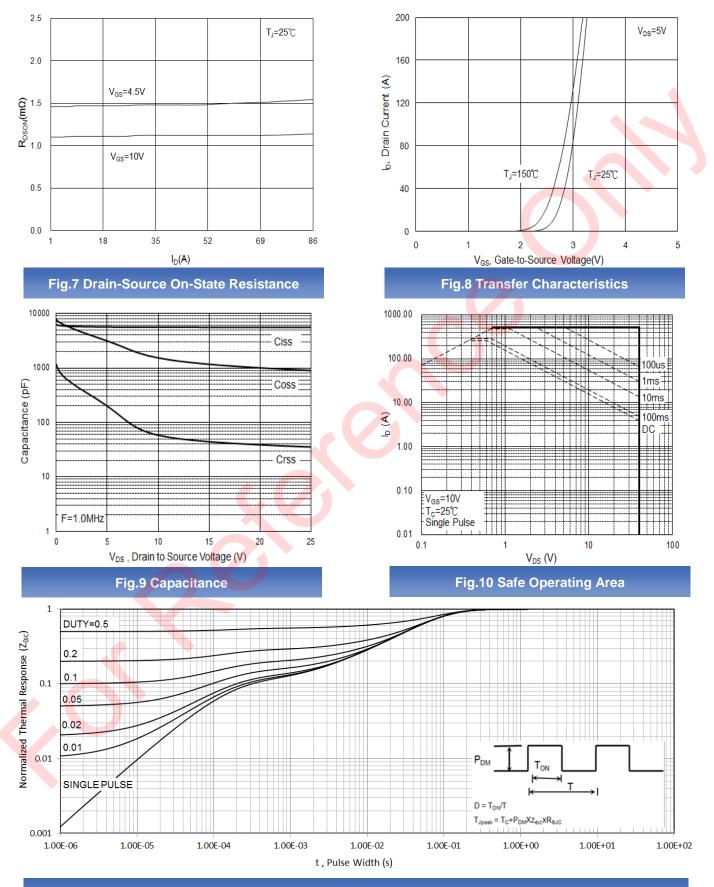


Fig.11 Transient Thermal Impedance

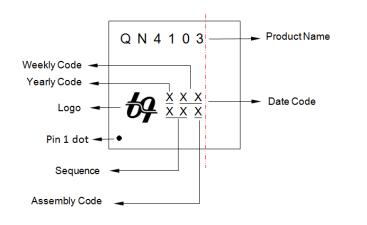
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Top Marking



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